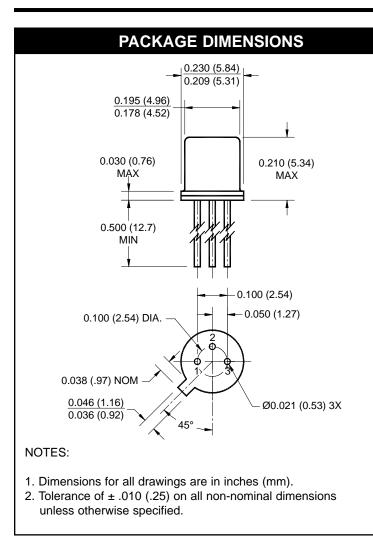
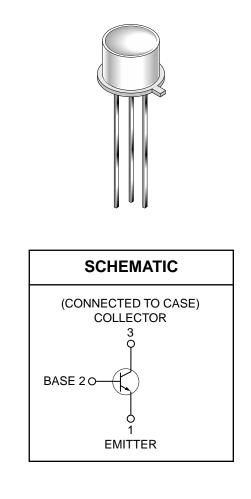


HERMETIC SILICON PHOTOTRANSISTOR

L14N1 L14N2





DESCRIPTION

The L14N1/L14N2 are silicon phototransistors mounted in a wide angle, TO-18 package.

FEATURES

- Hermetically sealed package
- Wide reception angle
- Device can be used as a photodiode by using the collector and base leads.



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ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise specified)							
Parameter	Symbol	Rating	Unit				
Operating Temperature	T _{OPR}	-65 to +125	°C				
Storage Temperature	T _{STG}	-65 to +150	°C				
Soldering Temperature (Iron) ^(3,4,5 and 6)	T _{SOL-I}	240 for 5 sec	°C				
Soldering Temperature (Flow) ^(3,4 and 6)	T _{SOL-F}	260 for 10 sec	°C				
Collector to Emitter Breakdown Voltage	V _{CEO}	30	V				
Collector to Base Breakdown Voltage	V _{CBO}	40	V				
Emitter to Base Breakdwon Voltage	V _{EBO}	5	V				
Power Dissipation $(T_A = 25^{\circ}C)^{(1)}$	PD	300	mW				
Power Dissipation $(T_C = 25^{\circ}C)^{(2)}$	PD	600	mW				

NOTE:

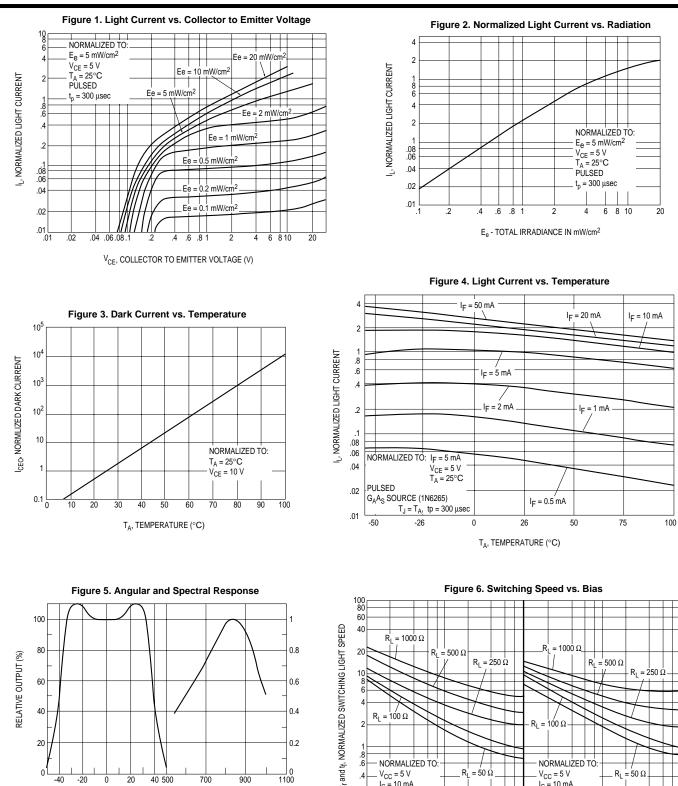
- 1. Derate power dissipation linearly 3.00 mW/°C above 25°C ambient.
- 2. Derate power dissipation linearly 6.00 mW/°C above 25°C case.
- 3. RMA flux is recommended.
- 4. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 5. Soldering iron tip $1/16^{"}$ (1.6mm) minimum from housing.
- 6. As long as leads are not under any stress or spring tension.
- 7. Light source is a GaAs LED emitting light at a peak wavelength of 940 nm.
- 8. Figure 1 and figure 2 use light source of tungsten lamp at 2870°K color temperature. A GaAs source of 3.0 mW/cm² is approximately equivalent to a tungsten source, at 2870°K, of 10 mW/cm².

PARAMETER	TEST CONDITIONS	SYMBOL	MIN	TYP	MAX	UNITS
Collector-Emitter Breakdown	I _c = 10 mA, Ee = 0	BV _{CEO}	30		—	V
Emitter-Base Breakdown	I _E = 100 μA, Ee = 0	BV _{EBO}	5		—	V
Collector-Base Breakdown	I _C = 100 μA, Ee = 0	BV _{CBO}	40		—	V
Collector-Emitter Leakage	V _{CE} = 10 V, Ee = 0	I _{CEO}	_		100	nA
Collector-Base leakage	$V_{CB} = 25 V, Ee = 0$	I _{CBO}	—		25	nA
Reception Angle at 1/2 Sensitivity		θ		±40		Degrees
On-State Collector Current L14N1	$Ee = 0.5 \text{ mW/cm}^2$, $V_{CE} = 5 \text{ V}^{(7,8)}$	I _{C(ON)}	1.0		—	mA
On-State Collector Current L14N2	$Ee = 0.5 \text{ mW/cm}^2$, $V_{CE} = 5 \text{ V}^{(7,8)}$	I _{C(ON)}	2.0			mA
On-State Photodiode Current	Ee = 1.5 mW/cm ² , V _{CB} = 5 V ^(7,8)	I _{CB(ON)}		5.0		μΑ
Rise Time	I_{C} = 10 mA, V_{CC} = 5 V, R_{L} =100 Ω	t _r		14		μs
Fall Time	I_{C} = 10 mA, V_{CC} = 5 V, R_{L} =100 Ω	t _f		16		μs
Saturation Voltage L14N1	$I_{\rm C} = 0.8 \text{ mA}, \text{ Ee} = 3.0 \text{ mW/cm}^{2(7,8)}$	V _{CE(SAT)}	—		0.40	V
Saturation Voltage L14N2	$I_{\rm C} = 1.6 \text{ mA}, \text{ Ee} = 3.0 \text{ mW/cm}^{2(7,8)}$	V _{CE(SAT)}	_		0.40	V



HERMETIC SILICON PHOTOTRANSISTOR

L14N1 L14N2



DS300308 6/01/01

0

-40

40 500

700

900

λ, WAVE LENGTH

(NANOMETERS)

20

θ, ANGULAR DISPLACEMENT

FROM OPTICAL AXIS

(DEGREES)

.8 6.

.4

.2

.1

1100

NORMALIZED TO:

RISE TIME

 $V_{CC} = 5 V$

 $I_{\rm C} = 10 \, \rm{mA}$ $\tilde{R}_{L} = 100 \Omega$

 $T_A = 25^{\circ}C$

.2 .4 .6 .8 1 $R_{1} = 50 \Omega$

2 4 8 10 .1

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FALL TIME

R_L = 50 Ω

2 4 6 8 10

NORMALIZED TO

 $V_{CC} = 5 V$ $I_{C} = 10 \text{ mA}$ $R_{L} = 100 \Omega$

.2 .4 .6.8 1

I_{CE}, OUTPUT CURRENT (mA)

= 25°C ΤA



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L14N1 L14N2

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